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PCB - ME-IO 18,8/28 TBUS DEV-PCB - 2202548

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Perfboard for the ME-IO 18,8 DEV-KIT; for HSCH 2,5 header; ideal for manual soldering



Why buy this product

- Hole matrix PCB for self-assembly
- Assembly area approx. 3,400 mm²
- Hole matrix dimension: 2.54 mm

RoHS

Key Commercial Data

Packing unit	1 STK
GTIN	4 055626 142609
GTIN	4055626142609
Weight per Piece (excluding packing)	16.400 g
Custom tariff number	85340011
Country of origin	Denmark

Technical data

General

Housing type	Component housing
Housing material	FR 4-21
Color	green

Ambient conditions

Ambient temperature (operation)	110 °C (depending on power dissipation)

Dimensions

Pitch	2.54 mm
	5 mm

Technical data

PCB - ME-IO 18,8/28 TBUS DEV-PCB - 2202548

Technical data

Technical data

Flammability rating according to UL 94	V0

Standards and Regulations

Flammability rating according to UL 94	V0

Environmental Product Compliance

China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

Classifications

eCl@ss

eCl@ss 4.0	27180401
eCl@ss 4.1	27180401
eCl@ss 5.0	27180506
eCl@ss 5.1	27180506
eCl@ss 8.0	27182702
eCl@ss 9.0	27182702

ETIM

ETIM 3.0	EC001031
ETIM 4.0	EC001031
ETIM 5.0	EC001031
ETIM 6.0	EC001031

UNSPSC

UNSPSC 6.01	31261501
UNSPSC 7.0901	31261501
UNSPSC 11	31261501
UNSPSC 12.01	31261501
UNSPSC 13.2	31261501

Accessories

Additional products

Electronic housing - ME-IO 18,8 DEV-KIT KMGY - 2202527



DEV-KIT ME-IO: contains 1 x ME-IO 18,8 housing and pluggable connection technology (HSCH with HSCP), supplied in individual parts

PCB - ME-IO 18,8/28 TBUS DEV-PCB - 2202548

Accessories

Plug - ME 18,8 TBUS 1,5/5 VPE1 KMGY - 2202549



Bus connector to connect ME-IO modules on the DIN rail; suitable for ME-IO DEV-KITS; contains ME 18,8 TBUS 1,5/5

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